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## (54) RADIATION SENSITIVE RESIN COMPOSITION

## (57)Abstract:

PROBLEM TO BE SOLVED: To obtain a positive or negative radiation sensitive resin compsn. useful as a chemical amplification resist which ensures especially low edge roughness in a fine pattern of  $\leq$  0.2 i m and has high sensitivity and high resolution.

SOLUTION: The positive radiation sensitive resin compsn. contains a fullerene deriv. soluble in a solvent for a resist, a radiation sensitive acid generating agent and an acid dissociable group-contg. resin or an alkali-soluble resin and an alkali solubility controlling agent. The negative radiation sensitive resin compsn. contains the fullerene deriv., the radiation sensitive acid generating agent, an alkali-soluble resin and a compd. capable of crosslinking the alkali- soluble resin in the presence of an acid.

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